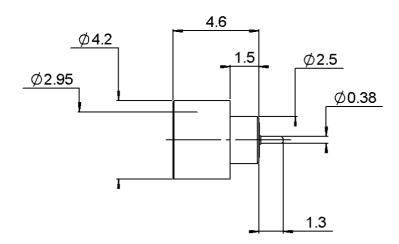
HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - FULL DETENT

R222.645.040

Series: SMP







All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (μm)
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	DILVER P DILVER P - GLASS	GOLD 0.5 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2

Issue: 0642 B

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



HERMETIC STRAIGHT MALE RECEPTACLE

Series: SMP

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SOLDER TYPE - FULL DETENT

PACKAGING

Standard	Unit	Other
100	'W' option	Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} \;\; \Omega \\ \text{Frequency} & & \textbf{0-18} \;\; \text{GHz} \end{array}$

VSWR 1.15 + 0,0000 x F(GHz) Maxi

Insertion loss RF leakage 0.12 $\sqrt{F(GHz)}$ dB Maxi - (NA - F(GHz)) dB Maxi

Voltage rating 335 Veff Maxi Dielectric withstanding voltage Insulation resistance 500 M Ω mini

ENVIRONMENTAL

Operating temperature -65/+165 ° C Hermetic seal 10-8 Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

Compliant with MIL-STD-348

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

6.8 N mini
6.8 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **0,1900** g

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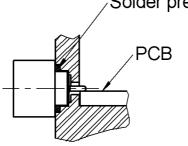


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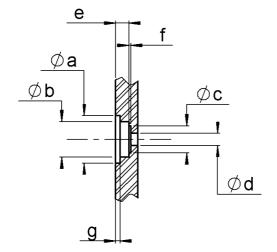
Series: SMP

Solder preform



- 1. Degrease and clean connector and box
- 2. Solder the connector on the panel we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C. Take care not to exceed 260°C during solder operation
- Solder the pin on the track we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C (only for ceramic substrate). Take care not to exceed 260°C during solder operation

Panel mounting hole



а	3,43 - 3,47
b	2,59 - 2,61
С	1,95 - 2,05
d	0,87 - 0,91
е	1,45 - 1,50
f	0,13 - 0,17
g	0,28 - 0,38

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